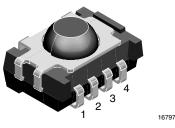
Vishay Semiconductors

IR Receiver Module for Light Barrier Systems



MECHANICAL DATA

Pinning: 1 = GND, 2 = N.C., 3 = OUT, 4 = V_S

FEATURES

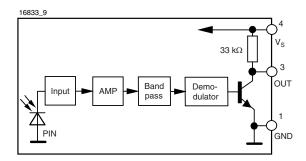
- Low supply current
- Photo detector and preamplifier in one package
- Internal filter for 38 kHz IR signals
- Shielding against EMI
- Supply voltage: 2.7 V to 5.5 V
- Visible light is suppressed by IR filter
- · Insensitive to supply voltage ripple and noise
- Compliant to RoHS directive 2002/95/EC and in accordance to WEEE 2002/96/EC

DESCRIPTION

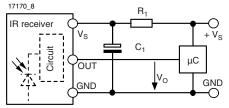
The TSOP5038 is a compact SMD IR receiver for sensor applications. It has a high gain for IR signals at 38 kHz. The detection level does not change when ambient light or strong IR signals are applied. It can receive continuous 38 kHz signals or 38 kHz bursts.

PARTS TABLE	
CARRIER FREQUENCY	SENSOR APPLICATIONS
38 kHz	TSOP5038

BLOCK DIAGRAM



APPLICATION CIRCUIT



The external components R, and C, are optional to improve the robustnes against electrical overstress (typical values are R₁ = 100 Ω , C₁ = 0.1 μ F). The output voltage V_o should not be pulled down to a level below 1 V by the external circuit.

The capacitive load at the output should be less than 2 nF.



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ABSOLUTE MAXIMUM RATINGS ⁽¹⁾				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage (pin 4)		V _S	- 0.3 to + 6.0	V
Supply current (pin 4)		۱ _S	5	mA
Output voltage (pin 3)		Vo	- 0.3 to 5.5	V
Voltage at output to supply		V _S - V _O	- 0.3 to (V _S + 0.3)	V
Output current (pin 3)		Ι _Ο	5	mA
Junction temperature		Tj	100	°C
Storage temperature range		T _{stg}	- 25 to + 85	°C
Operating temperature range		T _{amb}	- 25 to + 85	°C
Power consumption	$T_{amb} \le 85 \ ^{\circ}C$	P _{tot}	10	mW

Note

(1) Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability.

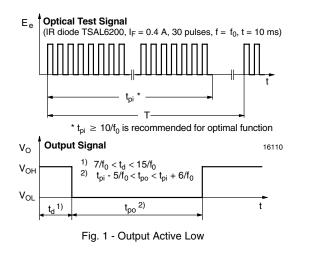
ELECTRICAL AND OPTICAL CHARACTERISTICS ⁽¹⁾						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply current (pin 4)	$E_v = 0, V_S = 5 V$	I _{SD}	0.65	0.85	1.05	mA
	E _v = 40 klx, sunlight	I _{SH}		0.95		mA
Supply voltage		Vs	2.7		5.5	V
Transmission distance	$\label{eq:Ev} \begin{array}{l} E_v = 0, test signal see fig. 1, \\ IR diode TSAL6200, \\ I_F = 400 mA \end{array}$	d		30		m
Output voltage low (pin 3)	$I_{OSL} = 0.5 \text{ mA}, E_e = 2 \text{ mW/m}^2,$ test signal see fig. 1	V _{OSL}			100	mV
Minimum irradiance	Pulse width tolerance: $t_{pi} - 5/f_0 < t_{po} < t_{pi} + 6/f_o,$ test signal see fig. 1	E _{e min.}		0.5	1	mW/m ²
Maximum irradiance	$\begin{array}{c} t_{pi} \text{ - } 5/f_o < t_{po} < t_{pi} + 6/f_o, \\ \text{test signal see fig. 1} \end{array}$	E _{e max.}	30			W/m ²
Directivity	Angle of half transmission distance	Φ1/2		± 50		deg

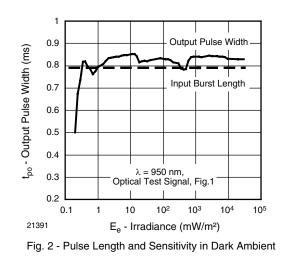
Note

 $^{(1)}$ T_{amb} = 25 °C, unless otherwise specified

TYPICAL CHARACTERISTICS

Tamb = 25 °C, unless otherwise specified







IR Receiver Module for Light Barrier Vishay Semiconductors Systems

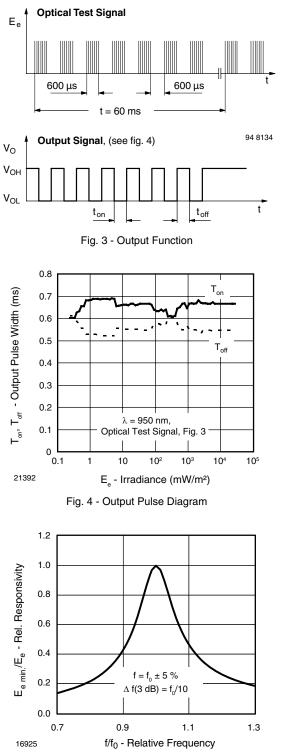
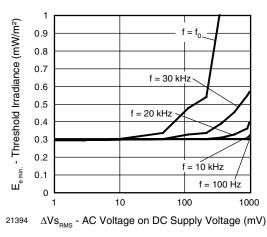
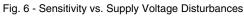


Fig. 5 - Frequency Dependence of Responsivity





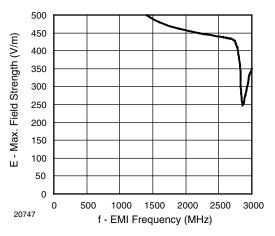


Fig. 7 - Sensitivity vs. Electric Field Disturbances

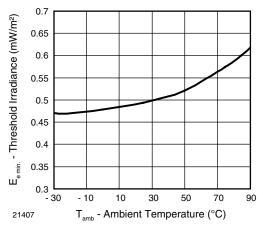


Fig. 8 - Sensitivity vs. Ambient Temperature

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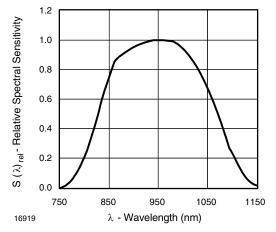


Fig. 9 - Relative Spectral Sensitivity vs. Wavelength

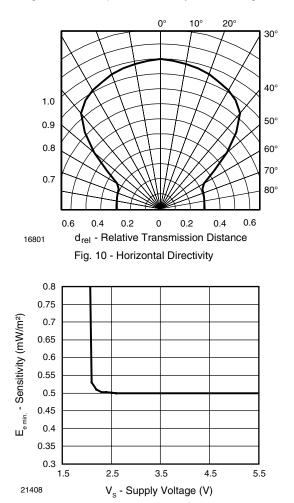
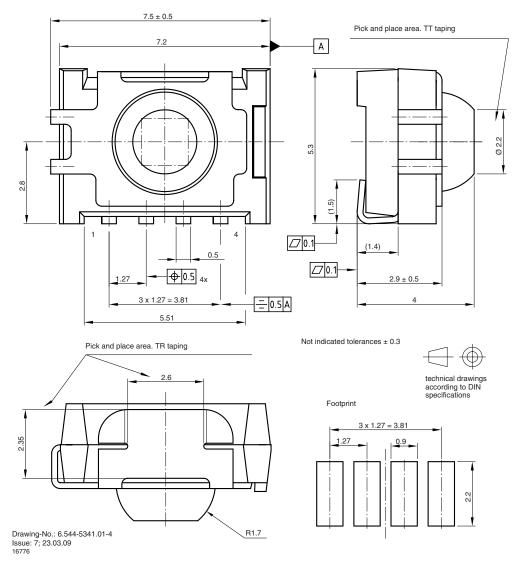


Fig. 11 - Sensitivity vs. Supply Voltage



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PACKAGE DIMENSIONS in millimeters



ASSEMBLY INSTRUCTIONS

Reflow Soldering

- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Excercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

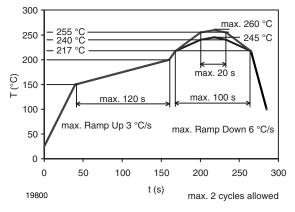
Manual Soldering

- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- · Handle products only after the temperature has cooled off

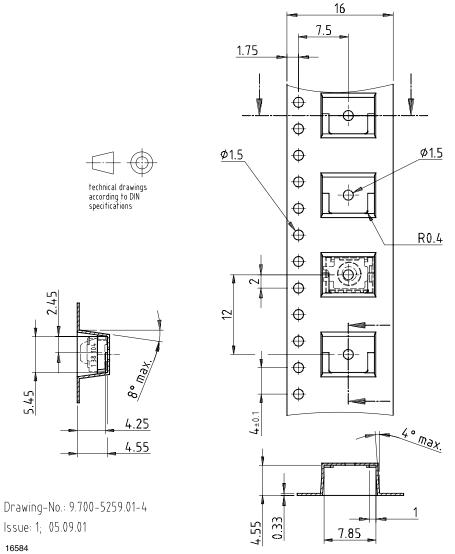
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VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE



TAPING VERSION TSOP..TT Dimensions in millimeters

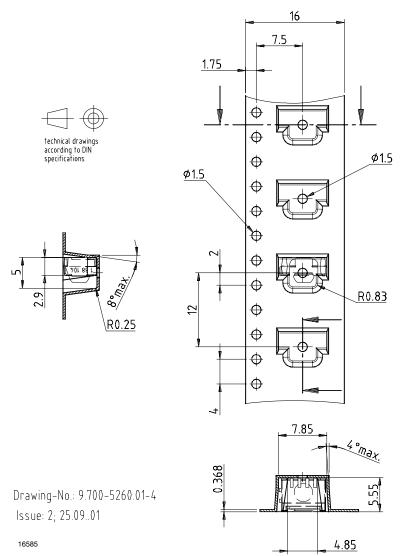


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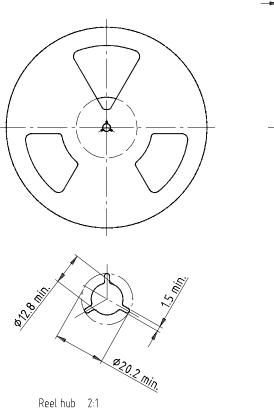
TAPING VERSION TSOP..TR Dimensions in millimeters

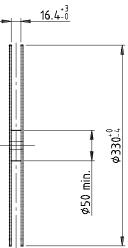




Vishay Semiconductors IR Receiver Module for Light Barrier Systems

REEL DIMENSIONS in millimeters





Form of the leave open of the wheel is supplier specific.

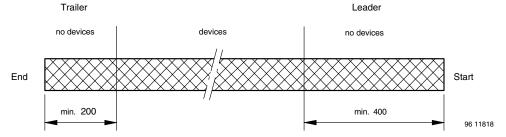
Dimension acc. to IEC EN 60 286-3

Tape width 16

$\ominus \oplus$	_
technical drawings according to DIN specifications	

Drawing refers to following types: Reel for blister carrier tape Version B Drawing-No.: 9.800-5052.V2-4 Issue: 1; 07.05.02 16734

LEADER AND TRAILER Dimensions in millimeters



COVER TAPE PEEL STRENGTH

According to DIN EN 60286-3 0.1 N to 1.3 N 300 ± 10 mm/min. 165° to 180° peel angle

LABEL

Standard bar code labels for finished goods

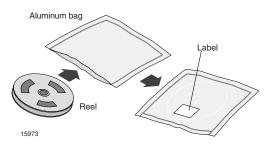
The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

IR Receiver Module for Light Barrier Vishay Semiconductors Systems

VISHAY SEMICONDUCTOR GMBH STANDARD BAR CODE PRODUCT LABEL (Finished Goods)				
PLAIN WRITTING	ABBREVIATION	LENGTH		
Item-description	-	18		
Item-number	INO	8		
Selection-code	SEL	3		
LOT-/serial-number	BATCH	10		
Data-code	COD	3 (YWW)		
Plant-code	PTC	2		
Quantity	QTY	8		
Accepted by	ACC	-		
Packed by	PCK	-		
Mixed code indicator	MIXED CODE	-		
Origin	XXXXXX+	Company logo		
LONG BAR CODE TOP	ТҮРЕ	LENGTH		
Item-number	Ν	8		
Plant-code	Ν	2		
Sequence-number	Х	3		
Quantity	Ν	8		
Total length	-	21		
SHORT BAR CODE BOTTOM	ТҮРЕ	LENGTH		
Selection-code	Х	3		
Data-code	Ν	3		
Batch-number	Х	10		
Filter	-	1		
Total length	-	17		

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity \leq 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C/ - 0 °C and < 5 % RH (dry air/nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or 24 h at 125 °C + 5 °C not suitable for reel or tubes. An EIA JEDEC standard JESD22-A112 level 4 label is included on all dry bags.

CAUTI This lag co MOISTURE -SENST	ntains d	L J		
1. Shelf life in sealed bag 12 months at <40°C and < 90% relative humidity (RH) $-$				
 After this bag is opened devices that will be subjected to infrared reflow, vapor-phase reflow, or equivalent processing (peak package body temp. 220°C) must be: Mounted within 72 hours at factory condition of ≤ 30°C/60%RH or Stored at ≤20% RH. Devices require baking before mounting if: Humidity Indicator Card is >20% when read at 23°C ± 5°C or a region of the package before mounting if: 				
4. If baking is required, devices may be bal	ked for:			
192 hours at 40°C + 5°C/-0°C and		37		
96 hours at 60±5°Cand <5%RH	For all device containers	or		
24 hours at 125±5°C	Not suitable for reels or tub	es		
Bag Scal Date:				
(If blank, see bar code label)				
Note: I.EVEI, defined by EIA JEDEC Standard JESD22-A112				
	·····	16943		

Example of JESD22-A112 level 4 label

Vishay Semiconductors IR Receiver Module for Light Barrier

Systems



ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electro-static sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



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Vishay

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